

# AZV99

## PECL/LVDS Oscillator Gain Stage & Buffer with Selectable Enable

[www.azmicrotek.com](http://www.azmicrotek.com)

### FEATURES

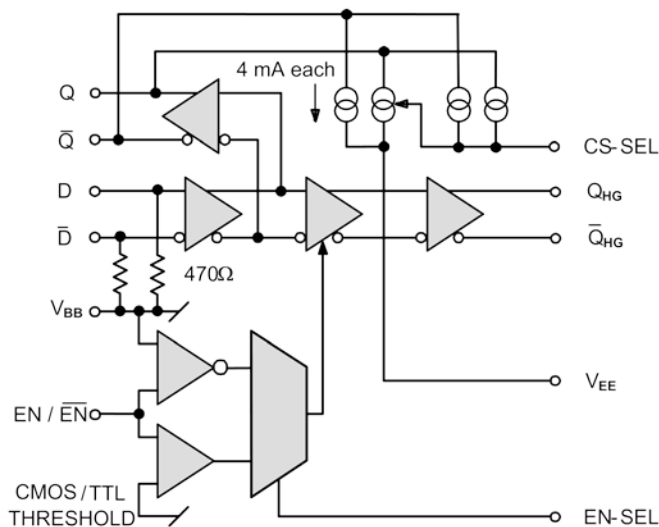
- Minimizes External Components
- Selectable Enable Polarity and Threshold (CMOS or PECL)
- 3V to 5.5V Power Supply
- Similar Operation as [AZ100LVEL16VT](#) except with LVDS Outputs

### DESCRIPTION

The [AZV99](#) is a specialized oscillator gain stage with an LVDS output buffer including an enable. The selectable enable input allows continuous oscillator operation by only controlling the  $Q_{HG}/\bar{Q}_{HG}$  outputs.

The AZV99 provides adjustable internal pull-down current sources for the Q/Q outputs. Internal input biasing further reduces the number of needed external components

### BLOCK DIAGRAM



### APPLICATIONS

- Crystal or saw oscillators that require minimal external components

### PACKAGE AVAILABILITY

- MLP8
- MLP16
- MSOP8
- Green/RoHS Compliant/Pb-Free

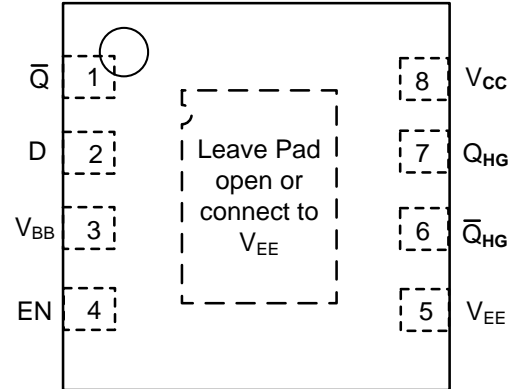
Order Number	Package	Marking
AZV99NG <sup>1</sup>	MLP8	V1G <Date Code> <sup>2</sup>
AZV99NBG <sup>1</sup>	MLP8	V8G <Date Code> <sup>2</sup>
AZV99NDG <sup>1</sup>	MLP8	V2G <Date Code> <sup>2</sup>
AZV99LG <sup>1</sup>	MLP16	AZMG <Date Code> <sup>2</sup>
AZV99T+ <sup>1</sup>	MSOP8	AZ+V99 <sup>2</sup>

<sup>1</sup> [Tape & Reel](#) - Add 'R1' at end of PN for 7in (1k parts), 'R2' (2.5k) for 13in

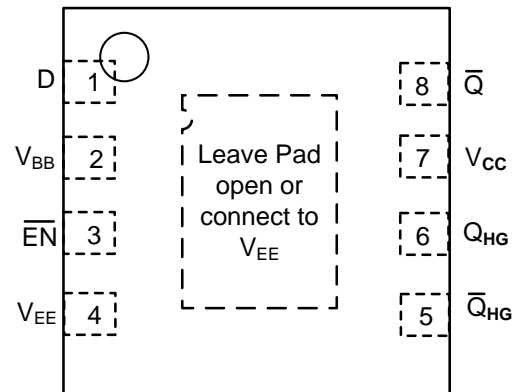
<sup>2</sup> See [www.azmicrotek.com](http://www.azmicrotek.com) for [date code format](#)

**PIN DESCRIPTION AND CONFIGURATION****Table 1 - Pin Description for AZV99N**

Pin	Name	Type	Function
1	Q	Output	Inverting PECL Output
2	D	Input	Data Input
3	V <sub>BB</sub>	Output	Reference Voltage
4	EN	Input	Output Enable
5	V <sub>EE</sub>	Power	Negative Supply
6	Q <sub>HG</sub>	Output	Inverting LVDS Output
7	Q <sub>HG</sub>	Output	LVDS Output
8	V <sub>CC</sub>	Power	Positive Supply

**Table 2 - Pin Description for AZV99NB**

Pin	Name	Type	Function
1	D	Input	Data Input
2	V <sub>BB</sub>	Output	Reference Voltage
3	EN	Input	Output Enable
4	V <sub>EE</sub>	Power	Negative Supply
5	Q <sub>HG</sub>	Output	Inverting LVDS Output
6	Q <sub>HG</sub>	Output	LVDS Output
7	V <sub>CC</sub>	Power	Positive Supply
8	Q	Output	Inverting PECL Output

**Table 3 - Pin Description for AZV99ND**

Pin	Name	Type	Function
1	Q	Output	Inverting PECL Output
2	D	Input	Data Input
3	V <sub>BB</sub>	Output	Reference Voltage
4	EN	Input	Output Enable
5	V <sub>EE</sub>	Power	Negative Supply
6	Q <sub>HG</sub>	Output	Inverting LVDS Output
7	Q <sub>HG</sub>	Output	LVDS Output
8	V <sub>CC</sub>	Power	Positive Supply

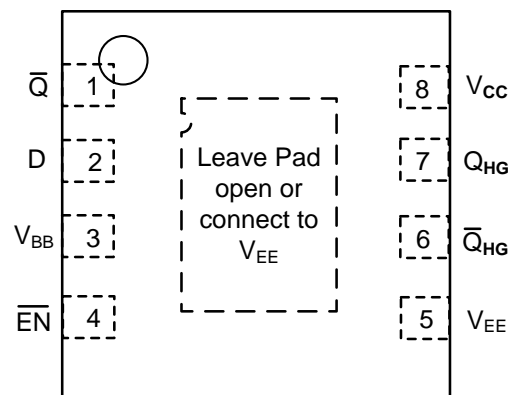


Table 4 - Pin Description for AZV99L

Pin	Name	Type	Function
1	NC	-	N/A
2	D	Input	Data Input
3	D	Input	Inverting Data Input
4	V <sub>BB</sub>	Output	Reference Voltage
5	EN	Input	Output Enable
6	NC	-	N/A
7	V <sub>EE</sub>	Power	Negative Supply
8	NC	-	N/A
9	EN-SEL	Input	Enable Polarity Select
10	Q <sub>HG</sub>	Output	Inverting LVDS Output
11	Q <sub>HG</sub>	Output	LVDS Output
12	CS-SEL	Input	Current Source Select
13	V <sub>CC</sub>	Power	Positive Supply
14	NC	-	N/A
15	Q	Output	PECL Output
16	Q	Output	Inverting PECL Output

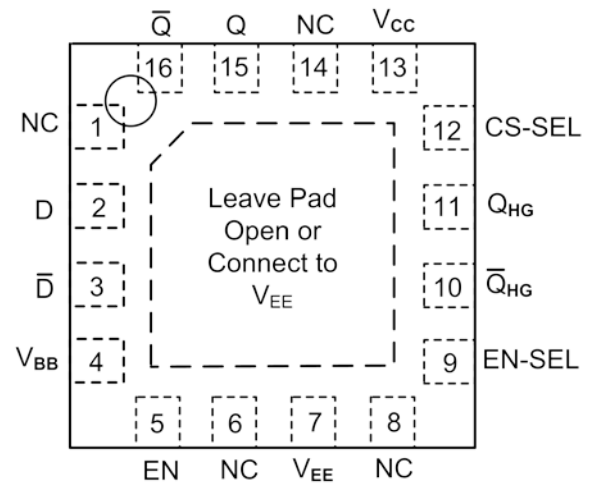
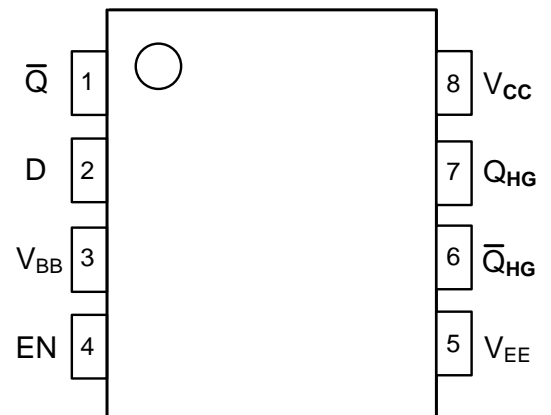


Table 5 - Pin Description for AZV99T

Pin	Name	Type	Function
1	Q	Output	Inverting PECL Output
2	D	Input	Data Input
3	V <sub>BB</sub>	Output	Reference Voltage
4	EN	Input	Output Enable
5	V <sub>EE</sub>	Power	Negative Supply
6	Q <sub>HG</sub>	Output	Inverting LVDS Output
7	Q <sub>HG</sub>	Output	LVDS Output
8	V <sub>CC</sub>	Power	Positive Supply



## ENGINEERING NOTES

The AZV99 is a specialized oscillator gain stage with LVDS output buffer including an enable. The enable input (EN) allows continuous oscillator operation by only controlling the  $Q_{HG}/\bar{Q}_{HG}$  outputs.

The AZV99 also provides a  $V_{BB}$  and  $470\Omega$  internal bias resistors from D to  $V_{BB}$  and  $\bar{D}$  to  $V_{BB}$ . The  $V_{BB}$  pin can support 1.5 mA sink/source current. Bypassing  $V_{BB}$  to ground with a  $0.01\ \mu\text{F}$  capacitor is recommended.

### FUNCTIONALITY MLP16 PACKAGE (AZV99L)

The MLP16 and die versions of the AZV99 provide a selectable enable (EN). Enable polarity and threshold can be selected to accommodate either CMOS/TTL or PECL input levels. See the enable truth table for enable function. If enable pull-up is desired in the CMOS/TTL mode, an external  $\leq 20\text{k}\Omega$  resistor connecting EN to  $V_{CC}$  will override the on-chip pull-down resistor.

Outputs Q/ $\bar{Q}$  each have a selectable on-chip pull-down current source. See the current source truth table for current source functions. External resistors may also be used to increase pull-down current to a maximum of 25mA (includes internal on-chip current source).

### FUNCTIONALITY MLP8 PACKAGE (AZV99NB & AZV99ND)

The MLP8 NA, NB and ND options of the AZV99 provide a PECL/ECL level enable input (EN). When the EN input is LOW, the Q and  $Q_{HG}/\bar{Q}_{HG}$  outputs pass data from the inputs. When EN is HIGH, the Q output continues to pass data while the  $Q_{HG}$  output is forced high and the  $\bar{Q}_{HG}$  output is forced low.

Only the Q output operates with a current source (4 mA) to  $V_{EE}$ . This is accomplished by internal bonding of CS-SEL. An external resistor may also be used to increase pull-down current to a maximum of 25mA (includes 4mA on-chip current source).

The AZV99NB and AZV99ND versions operate with a single ended data input (D). The D input is internally bonded directly to the  $V_{BB}$  pin bypassing the  $470\Omega$  bias resistor.

### FUNCTIONALITY MLP8 PACKAGE (AZV99N) & MSOP8 PACKAGE (AZV99T)

The MSOP8 (T) and MLP8 (N) versions of the AZV99 provide a CMOS/TTL level enable input (EN). When the EN input is HIGH, the Q and  $Q_{HG}/\bar{Q}_{HG}$  outputs pass data from the inputs. When EN is LOW, the Q output continues to pass data while the  $Q_{HG}$  output is forced high and the  $\bar{Q}_{HG}$  output is forced low.

Only the Q output operates with a current source (4 mA) to  $V_{EE}$ . This is accomplished by internal bonding of CS-SEL. An external resistor may also be used to increase pull-down current to a maximum of 25mA (includes 4mA on-chip current source).

The MSOP8 (T) and MLP8 (N) AZV99 operates with a single ended data input (D). The D input is internally bonded directly to the  $V_{BB}$  pin bypassing the  $470\Omega$  bias resistor.

Table 6 – Enable Truth Table

EN-SEL	EN/ $\overline{\text{EN}}$	Q/Q	Q <sub>HG</sub>	$\overline{\text{Q}}_{\text{HG}}$
NC	PECL Low, V <sub>EE</sub> or NC	Data	Data	Data
	PECL High or V <sub>CC</sub>	Data	High	Low
V <sub>EE</sub> <sup>1</sup>	CMOS/TTL Low, V <sub>EE</sub> or NC	Data	High	Low
	CMOS/TTL High or V <sub>CC</sub> <sup>2</sup>	Data	Data	Data

- 1 EN-SEL connections must be less than 1Ω.
- 2 An external ≤ 20kΩ pull-up resistor between EN and VCC ensures a High when the EN pin is not driven.

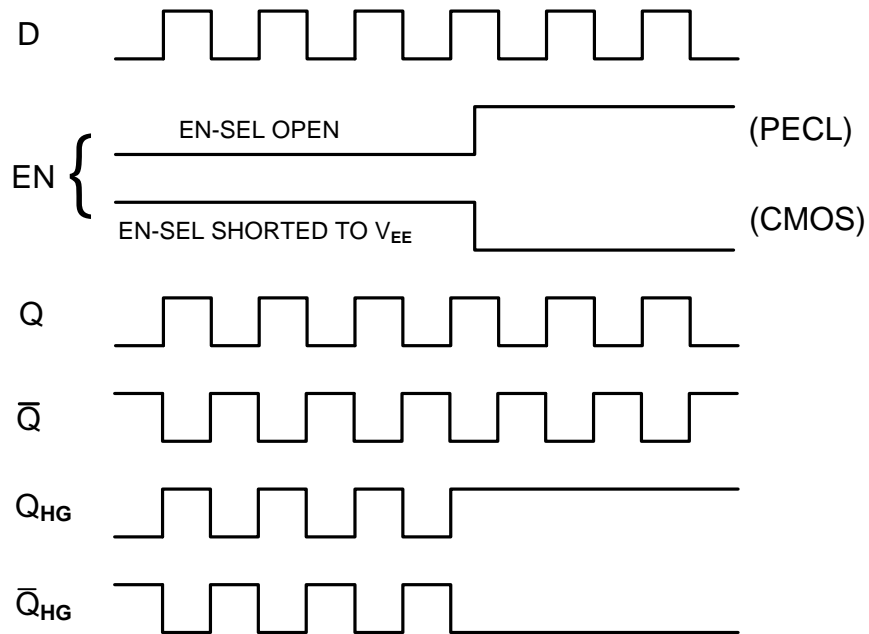


Figure 1 – Timing Diagram

Table 7 - Current Source Truth Table

CS-SEL	Q	$\overline{\text{Q}}$
NC	4mA typ	4mA typ
V <sub>EE</sub> <sup>1</sup>	8mA typ	8mA typ
V <sub>CC</sub> <sup>1</sup>	0	4mA typ

- 1 Connection must be less than 1Ω

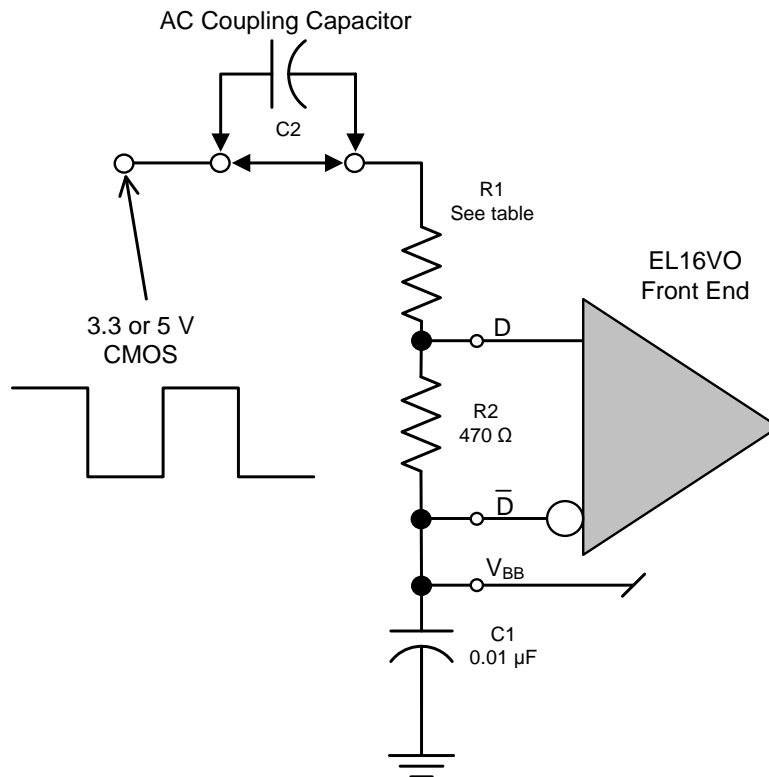


Figure 2 - Application circuit for CMOS inputs

Table 8 – Recommended Component Values for CMOS Single Ended Inputs

Input Type	R1 <sup>1</sup> Value	
	AC Coupled (C2 in circuit)	DC Coupled (C2 shorted)
3.3 V CMOS	1.1 kΩ	2.0 kΩ
5.0 V CMOS	1.6 kΩ	3.3 kΩ

- R1 should be chosen so that the input swing on the D input with respect to D is in the range of ±80 to ±1000 mV, per the AC Characteristics table and the D input is < ±750 mV with respect to V<sub>BB</sub>.

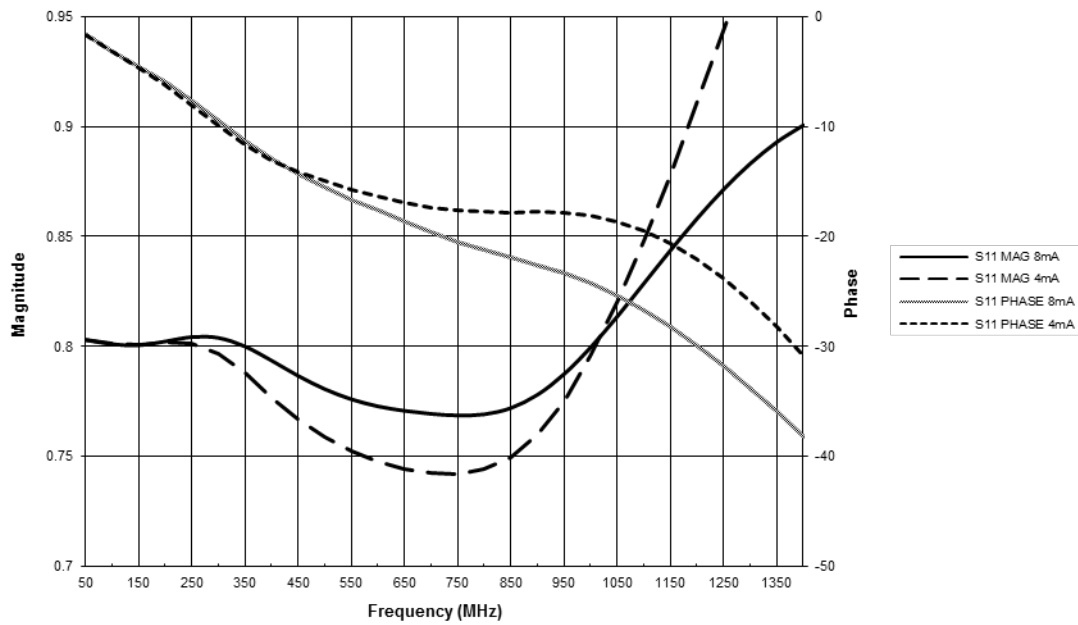


Figure 3 - S11, 50Ω AC load

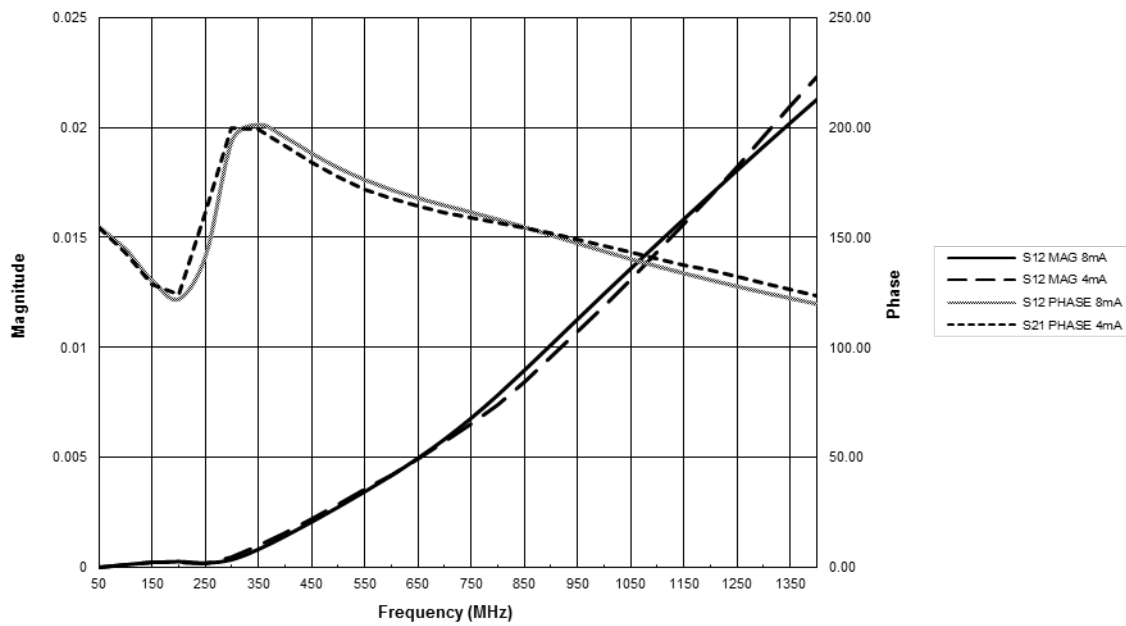


Figure 4 - S12, 50Ω AC load

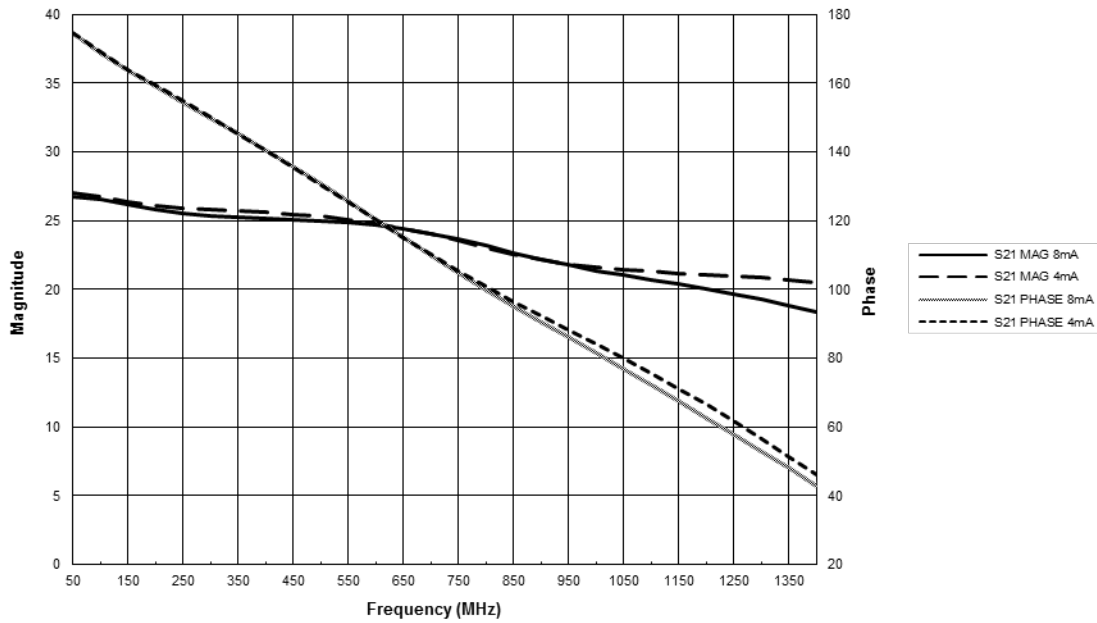


Figure 5 – S21, 50Ω AC load

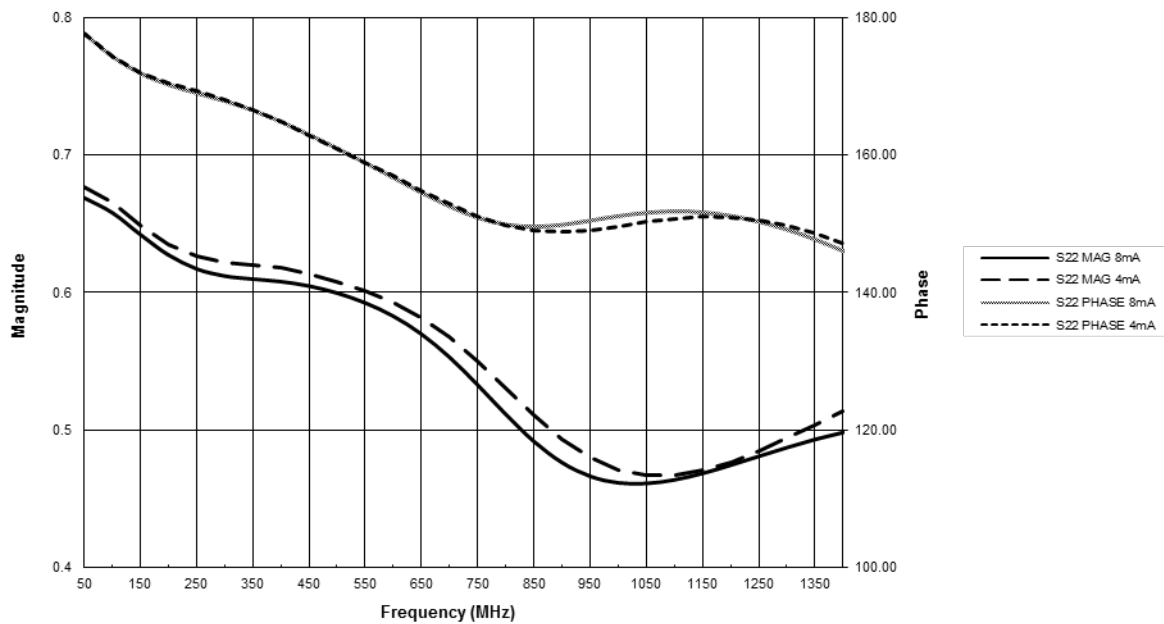


Figure 6 – S22, 50Ω AC load



**PERFORMANCE DATA**

Table 9 – Absolute Maximum Ratings

Absolute Maximum Ratings are those values beyond which device life may be impaired.

Symbol	Characteristic	Condition	Rating	Unit
V <sub>CC</sub>	PECL Power Supply	V <sub>EE</sub> = 0V	0 to + 6.0	V
V <sub>I</sub>	PECL Input Voltage	V <sub>EE</sub> = 0V	0 to + 6.0	V
V <sub>D/</sub>	D/D Input Voltage	Referenced to V <sub>BB</sub>	±0.75	V
I <sub>OUT</sub>	Output Current	Continuous Q/Q	25	mA
		Surge Q/Q	50	
		Continuous Q <sub>HG</sub> /Q <sub>HG</sub>	5	
		Surge Q <sub>HG</sub> /Q <sub>HG</sub>	10	
T <sub>A</sub>	Operating Temperature Range	-	-40 to +85	°C
T <sub>STG</sub>	Storage Temperature Range	-	-65 to +150	°C
ESD <sub>HBM</sub>	Human Body Model Electro Static Discharge	-	2500	V
ESD <sub>MM</sub>	Machine Model Electro Static Discharge	-	200	V
ESD <sub>CDM</sub>	Charged Device Model Electro Static Discharge	-	2000	V

Table 10 - 100K LVPECL DC Characteristics

100K LVPECL DC Characteristics (V<sub>EE</sub> = GND, V<sub>CC</sub> = +3.3V)

Symbol	Characteristic	-40°C		0°C		25°C		85°C		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>OH</sub>	Output HIGH Voltage <sup>1,2</sup>	2255	2465	2275	2465	2275	2465	2275	2465	mV
V <sub>OL</sub>	Output LOW Voltage <sup>1,2</sup>	1375	1745	1400	1680	1400	1680	1400	1680	mV
V <sub>IH</sub>	Input HIGH Voltage D,EN (EN-SEL open) <sup>1</sup>	2135	2560	2135	2560	2135	2560	2135	2560	mV
	Input HIGH Voltage EN (EN-SEL tied to V <sub>EE</sub> ) <sup>1</sup>	2000	V <sub>CC</sub>	2000	V <sub>CC</sub>	2000	V <sub>CC</sub>	2000	V <sub>CC</sub>	mV
V <sub>IL</sub>	Input LOW Voltage D,EN (EN-SEL open) <sup>1</sup>	1400	1825	1400	1825	1400	1825	1400	1825	mV
	Input LOW Voltage EN (EN-SEL tied to V <sub>EE</sub> ) <sup>1</sup>	GND	800	GND	800	GND	800	GND	800	mV
V <sub>BB</sub>	Reference Voltage <sup>1</sup>	1910	2050	1910	2050	1910	2050	1910	2050	mV
I <sub>IH</sub>	Input HIGH Current EN <sup>3</sup>		150		150		150		150	μA
I <sub>IL</sub>	Input LOW Current EN <sup>3</sup>	0.5		0.5		0.5		0.5		μA
I <sub>EE</sub>	Power Supply Current <sup>2</sup>		48		48		48		48	mA

1 Voltage levels vary 1:1 with V<sub>CC</sub>

2 Specified with CS-SEL open

3 Specified with EN-SEL open

Table 11 - 100K PECL DC Characteristics

100K PECL DC Characteristics ( $V_{EE} = \text{GND}$ ,  $V_{CC} = +5.0\text{V}$ )

Symbol	Characteristic	-40°C		0°C		25°C		85°C		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
$V_{OH}$	Output HIGH Voltage <sup>1,2</sup>	3955	4165	3975	4165	3975	4165	3975	4165	mV
$V_{OL}$	Output LOW Voltage <sup>1,2</sup>	3075	3445	3100	3380	3100	3380	3100	3380	mV
$V_{IH}$	Input HIGH Voltage D,EN (EN-SEL open) <sup>1</sup>	3835	4260	3835	4260	3835	4260	3835	4260	mV
	Input HIGH Voltage EN (EN-SEL tied to $V_{EE}$ ) <sup>1</sup>	2000	$V_{CC}$	2000	$V_{CC}$	2000	$V_{CC}$	2000	$V_{CC}$	mV
$V_{IL}$	Input LOW Voltage D,EN (EN-SEL open) <sup>1</sup>	3100	3525	3100	3525	3100	3525	3100	3525	mV
	Input LOW Voltage EN (EN-SEL tied to $V_{EE}$ ) <sup>1</sup>	GND	800	GND	800	GND	800	GND	800	mV
$V_{BB}$	Reference Voltage <sup>1</sup>	3610	3750	3610	3750	3610	3750	3610	3750	mV
$I_{IH}$	Input HIGH Current EN <sup>3</sup>		150		150		150		150	$\mu\text{A}$
$I_{IL}$	Input LOW Current EN <sup>3</sup>	0.5		0.5		0.5		0.5		$\mu\text{A}$
$I_{EE}$	Power Supply Current <sup>2</sup>		48		48		48		52	mA

<sup>1</sup> Voltage levels vary 1:1 with  $V_{CC}$

<sup>2</sup> Specified with CS-SEL open

<sup>3</sup> Specified with EN-SEL open

Table 12 – LVDS DC Characteristics

LVDS DC Characteristics for  $Q_{HG}/Q_{HG}$  Outputs<sup>1</sup> ( $V_{EE} = \text{GND}$ ,  $V_{CC} = +3.0\text{V}$  to  $+5.5\text{V}$ )

Symbol	Characteristic	-40°C		0°C		25°C		85°C		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
$V_{OH}$	Output HIGH Voltage		1600		1600		1600		1600	mV
$V_{OL}$	Output LOW Voltage	900		900		900		900		mV
$V_{OC}$	Output Common Mode Voltage <sup>2</sup>	1125	1375	1125	1375	1125	1375	1125	1375	mV
$\Delta V_{OC}$	Change in Common Mode Voltage <sup>3</sup>	-50	50	-50	50	-50	50	-50	50	mV
$V_{OUT}$	Single-Ended Output Swing	250	450	250	450	250	450	250	450	mV
$V_{DIFF\_OUT}$	Differential Output Swing	500	900	500	900	500	900	500	900	mV

<sup>1</sup> Specified with 100 $\Omega$  resistor connecting  $Q_{HG}$  and  $Q_{HG}$  together.

<sup>2</sup> Common mode voltage is the center voltage between  $Q_{HG}$  and  $Q_{HG}$  during a steady state.

<sup>3</sup> Change in common mode voltage is the difference between common mode voltages at opposite binary states.

Table 13 – AC Characteristics

AC Characteristics ( $V_{EE} = -3.0V$  to  $-5.5V$ ;  $V_{CC}=GND$  or  $V_{EE}=GND$ ;  $V_{CC} = +3.0V$  to  $+5.5V$ )

Symbol	Characteristic	-40°C			0°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$t_{PLH}/t_{PHL}$	Propagation Delay													
	D to Q/Q <sup>1</sup>			400			400			400			430	ps
	D to Q <sub>HG</sub> /Q <sub>HG</sub> <sup>2</sup>			550			550			550			630	ps
$t_{SKEW}$	Duty Cycle Skew <sup>3</sup>		5	20		5	20		5	20		5	20	ps
$V_{pp}$ (AC)	Input Swing <sup>4</sup>	80		1000	80		1000	80		1000	80		1000	mV
$t_r/t_f$	Output Rise/Fall <sup>1</sup> (20% - 80%) - Q	100		260	100		260	100		260	100		260	
	Output Rise/Fall <sup>1</sup> (20% - 80%) - Q <sub>HG</sub>	180		280	180		280	180		280	180		280	ps

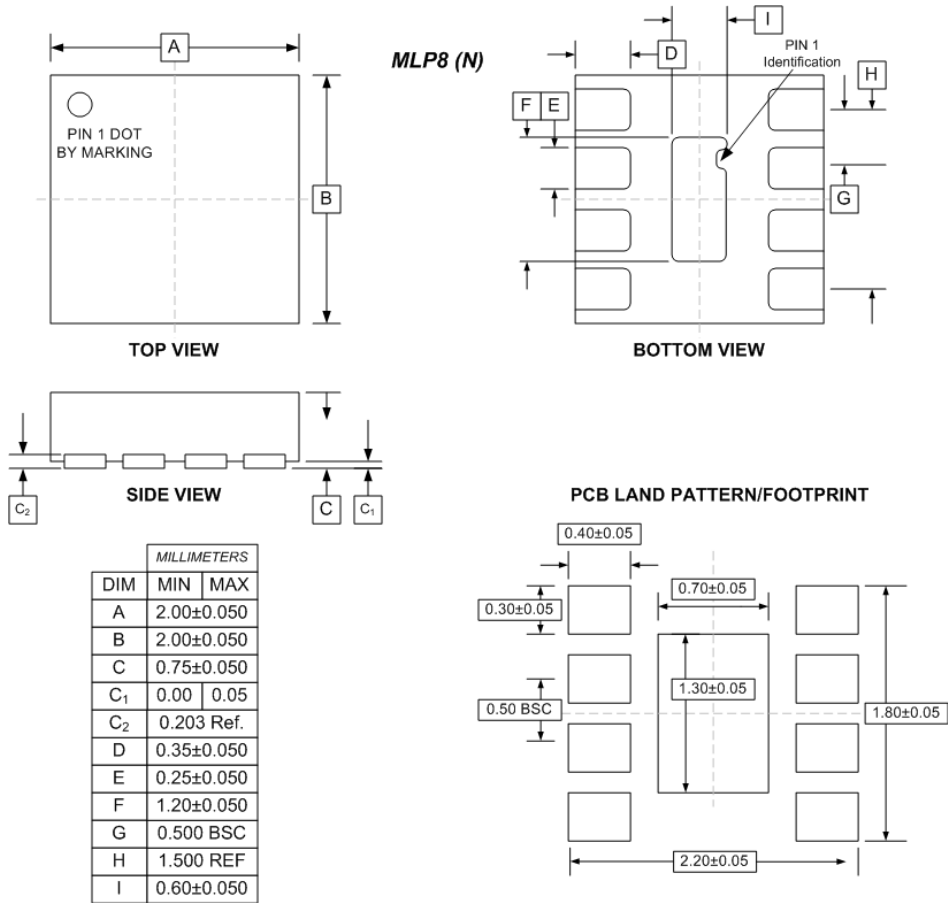
<sup>1</sup> Specified with CS-SEL connected to  $V_{EE}$  and Q/Q with AC coupled 50Ω loads.

<sup>2</sup> Specified with 100Ω resistor connecting Q<sub>HG</sub> and Q<sub>HG</sub> together.

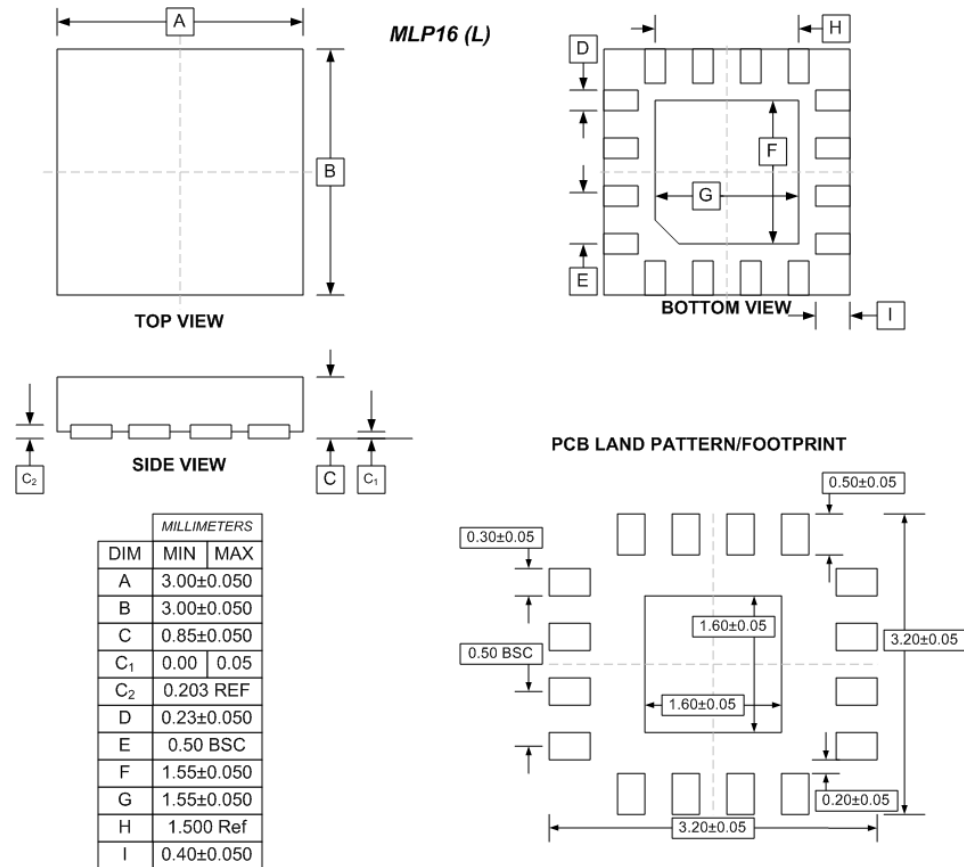
<sup>3</sup> Duty cycle skew is the difference between a  $t_{PLH}$  and  $t_{PHL}$  propagation delay through a device.

<sup>4</sup> The peak-to-peak differential input swing is the range for which AC parameters guaranteed.  $V_D$  and  $V$  must remain within the range of ±750 mV with respect to  $V_{BB}$ .

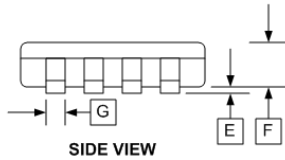
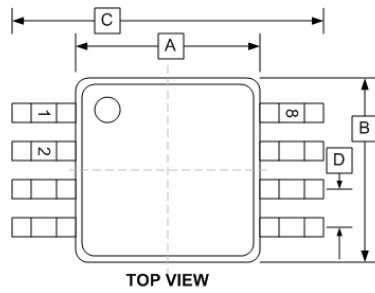
**PACKAGE DIAGRAM**  
MLP8  
Green/RoHS compliant/Pb-Free  
MSL=1



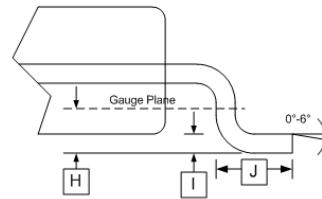
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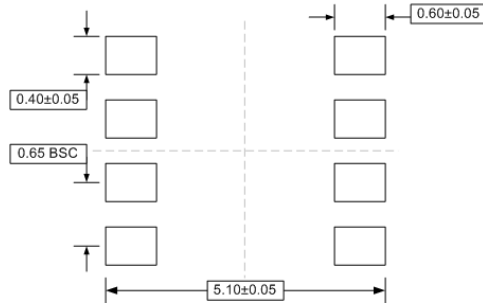
**PACKAGE DIAGRAM**  
**MSOP8**  
 Green/RoHS compliant/Pb-Free  
 MSL=1



MSOP8 (T)



PCB LAND PATTERN/FOOTPRINT  
 Dimensions in mm



INCHES		
DIM	MIN	MAX
A	0.118±0.004	
B	0.118±0.004	
C	0.192±0.008	
D	0.0256 TYP	
E	0.004±0.002	
F	0.034±0.002	
G	0.009±0.014	
H	0.010	
I	0.006±0.002	
J	0.021±0.004	

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